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# Product Change Notification - KSRA-08ARTV265 (Printer Friendly)

## Date:

07 Jul 2017

## **Product Category:**

Memory

## **Notification subject:**

CCB 2985: Initial Notice: Qualification of 36.3K process technology for selected products of the 24AAxx and 24LCxx device families available in 5L SC70 package.

## **Notification text:**

#### **PCN Status:**

Initial notification.

## **Microchip Parts Affected:**

Please open the attachments found in the attachments field below labeled as PCN\_#\_Affected\_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

## **Description of Change:**

Qualification of 36.3K process technology for selected products of the 24AAxx and 24LCxx device families available in 5L SC70 package.

## Pre Change:

Available in 160K wafer technology fabricated at Microchip fabrication sites FAB2 and FAB4 (Tempe, AZ and Gresham, OR, USA) using 8 inch wafers

# Post Change:

Available in 160K wafer technology fabricated at Microchip fabrication sites FAB2 and FAB4 (Tempe, AZ and Gresham, OR, USA) using 8 inch wafers or available in 36.3K wafer technology fabricated at FAB 5 (Colorado Springs, CO, USA) using 6 inch wafers

## **Pre and Post Change Summary:**

|                       | Pre Change   | Post Change  |                                     |  |  |  | Pre Change Post Change |  |  |  |  |
|-----------------------|--|--|-------------------------------------|--|--|--|------------------------|--|--|--|--|
|                       |  |  |                                     |  |  |  |                        |  |  |  |  |
| Wafer Technology      | 160K wafer<br>technology   | 160K wafer<br>technology   | 36.3K wafer<br>technology           |  |  |  |                        |  |  |  |  |
| Fabrication Location  | Microchip<br>Fabrication Sites<br>FAB 2 and FAB4<br>(Tempe, AZ and<br>Gresham, OR,<br>USA) | Microchip<br>Fabrication Sites<br>FAB 2 and FAB4<br>(Tempe, AZ and<br>Gresham, OR,<br>USA) | FAB 5 (Colorado<br>Springs, CO USA) |  |  |  |                        |  |  |  |  |
| Wafer Diameter        | 8 inches (200 mm)  | 8 inches (200 mm)  | 6 inches (150 mm)                   |  |  |  |                        |  |  |  |  |
| Quality certification | ISO/TS16949  | ISO/TS16949  | ISO9001/TS16949                     |  |  |  |                        |  |  |  |  |

#### Impacts to Data Sheet:

None

## **Change Impact:**

None

#### Reason for Change:

To improve manufacturability by qualifying an additional fabrication site.

#### **Change Implementation Status:**

In Progress

## **Estimated Qualification Completion Date:**

August 2017

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

## **Time Table Summary:**

|                             | July 2017 |    |    |    |    |    | August 2017 |    |    |    |    |
|-----------------------------|-----------|----|----|----|----|----|-------------|----|----|----|----|
| Workweek                    | 26        | 27 | 28 | 29 | 30 | 31 | 31          | 32 | 33 | 34 | 35 |
| Initial PCN<br>Issue Date   |           | Х  |    |    |    |    |             |    |    |    |    |
| Qual Report<br>Availability |           |    |    |    |    |    |             |    |    |    | X  |
| Final PCN<br>Issue Date     |           |    |    |    |    |    |             |    |    |    | X  |

# Method to Identify Change:

Traceability code

# **Qualification Plan:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual Plan.

#### **Revision History:**

July 07, 2017: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

## Attachment(s):

PCN\_KSRA-08ARTV265\_Affected CPN.pdf PCN\_KSRA-08ARTV265\_Qual Plan.pdf PCN\_KSRA-08ARTV265\_Affected CPN.xlsx

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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